

RCJ700N20 Nch 200V 70A Power MOSFET

| V _{DSS} | 200V |
|----------------------------|--------|
| R _{DS(on)} (Max.) | 42.7mΩ |
| I _D | 70A |
| P _D | 297W |

Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Drive circuits can be simple.
- 4) Parallel use is easy.
- 5) Pb-free lead plating ; RoHS compliant
- 6) 100% Avalanche tested

Application

Switching Power Supply

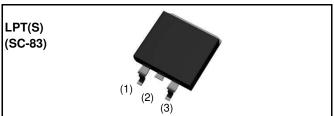
Automotive Motor Drive

Automotive Solenoid Drive

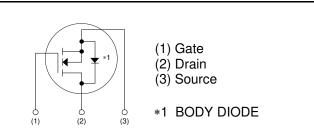
●Absolute maximum ratings (T_a = 25°C)

Parameter Symbol Value Unit V_{DSS} V Drain - Source voltage 200 I_D^{*1} $T_c = 25^{\circ}C$ ±70 А Continuous drain current I_D^{*1} $T_{c} = 100^{\circ}C$ ±38 А *2 Pulsed drain current ±140 А I_{D,pulse} V V_{GSS} Gate - Source voltage ±30 *3 Avalanche energy, single pulse 396 mJ E_{AS} *3 Avalanche current 35 А I_{AR} $T_c = 25^{\circ}C$ 297 P_{D} W Power dissipation $T_a = 25^{\circ}C^{*4}$ P_{D} 1.56 W Ti 150 °C Junction temperature T_{stg} °C Range of storage temperature -55 to +150

Outline



Inner circuit



Packaging specifications

| | Packaging | Taping |
|------|---------------------------|-----------|
| Туре | Reel size (mm) | 330 |
| | Tape width (mm) | 24 |
| | Basic ordering unit (pcs) | 1,000 |
| | Taping code | TL |
| | Marking | RCJ700N20 |

Thermal resistance

| Parameter | Symbol | Values | | | Unit |
|--|------------|--------|------|------|------|
| Farameter | Symbol | Min. | Тур. | Max. | Unit |
| Thermal resistance, junction - case | R_{thJC} | - | - | 0.42 | °C/W |
| Thermal resistance, junction - ambient *4 | R_{thJA} | - | - | 80 | °C/W |
| Soldering temperature, wavesoldering for 10s | T_{sold} | - | - | 265 | °C |

•Electrical characteristics ($T_a = 25^{\circ}C$)

| Deremeter | Symbol | Conditions | Values | | | Unit | |
|--|---------------------------|-----------------------------------|--------|------|------|------|--|
| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit | |
| Drain - Source breakdown voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 1mA$ | 200 | - | - | V | |
| | | $V_{DS} = 200V, V_{GS} = 0V$ | | | 05 | | |
| Zara gata valtaga drain aurrant | | $T_j = 25^{\circ}C$ | - | - | 25 | μA | |
| Zero gate voltage drain current | I _{DSS} | $V_{DS} = 200V, V_{GS} = 0V$ | | - | 100 | | |
| | | T _j = 125°C | - | | | | |
| Gate - Source leakage current | I _{GSS} | $V_{GS} = \pm 30V, \ V_{DS} = 0V$ | - | - | ±100 | nA | |
| Gate threshold voltage | V _{GS (th)} | $V_{DS} = 10V, I_{D} = 1mA$ | 3.0 | - | 5.0 | V | |
| | ${\sf R}_{\sf DS(on)}$ *5 | $V_{GS} = 10V, I_{D} = 35A$ | - | 30.5 | 42.7 | | |
| Static drain - source on - state resistance | | $V_{GS} = 10V, I_{D} = 35A$ | | 62.0 | 97.0 | mΩ | |
| | | T _j = 125°C | - | 62.0 | 87.0 | | |
| Forward transfer admittance | 9 _{fs} | $V_{DS} = 10V, I_{D} = 35A$ | 15.3 | 30.6 | - | S | |

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•Electrical characteristics ($T_a = 25^{\circ}C$)

| Parameter | Symbol | Conditions | Values | | | Unit |
|------------------------------|------------------------|------------------------------------|--------|------|------|------|
| Farameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
| Input capacitance | C _{iss} | $V_{GS} = 0V$ | - | 6900 | - | |
| Output capacitance | C _{oss} | $V_{DS} = 25V$ | - | 400 | - | pF |
| Reverse transfer capacitance | C _{rss} | f = 1MHz | - | 230 | - | |
| Turn - on delay time | t _{d(on)} *5 | $V_{DD} \simeq 100V, V_{GS} = 10V$ | - | 70 | - | |
| Rise time | t _r *5 | I _D = 35A | - | 340 | - | 20 |
| Turn - off delay time | t _{d(off)} *5 | $R_L = 2.8\Omega$ | - | 160 | - | ns |
| Fall time | t _f *5 | $R_G = 10\Omega$ | - | 160 | - | |

•Gate Charge characteristics ($T_a = 25^{\circ}C$)

| Parameter | Symbol | Conditions | Values | | | Unit |
|----------------------|------------------------|-----------------------------------|--------|------|------|------|
| Farameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
| Total gate charge | Q_g^{*5} | $V_{DD} \simeq 100V$ | - | 125 | - | |
| Gate - Source charge | Q_{gs} *5 | I _D = 70A | - | 40 | - | nC |
| Gate - Drain charge | Q_{gd} *5 | $V_{GS} = 10V$ | - | 50 | - | |
| Gate plateau voltage | V _(plateau) | $V_{DD} \simeq 100V, \ I_D = 70A$ | - | 7.0 | - | V |

●Body diode electrical characteristics (Source-Drain)(T_a = 25°C)

| Parameter | Symbol | Conditions | Values | | | Unit |
|---------------------------|-------------------------------|----------------------------|--------|------|------|------|
| Farameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
| Continuous source current | I_{S}^{*1} | T _c = 25°C | - | - | 70 | А |
| Pulsed source current | I_{SM} *2 | $r_{c} = 25.0$ | - | - | 140 | А |
| Forward voltage | V_{SD} *5 | $V_{GS} = 0V, I_{S} = 70A$ | - | - | 1.5 | V |
| Reverse recovery time | t _{rr} *5 | I _S = 35A | - | 130 | - | ns |
| Reverse recovery charge | Q _{rr} ^{*5} | di/dt = 100A/µs | - | 600 | - | nC |

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10 $\mu s,$ Duty cycle \leq 1%

*3 L \simeq 500 μ H, V_{DD} = 50V, Rg = 25 Ω , starting T_j = 25°C

*4 Mounted a epoxy PCB FR4 (25×27×0.8mm)

*5 Pulsed

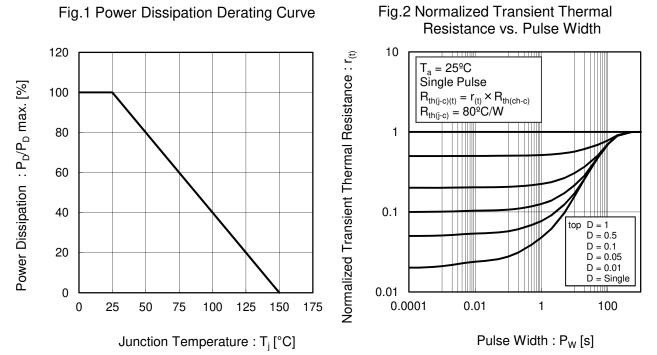


Fig.1 Power Dissipation Derating Curve

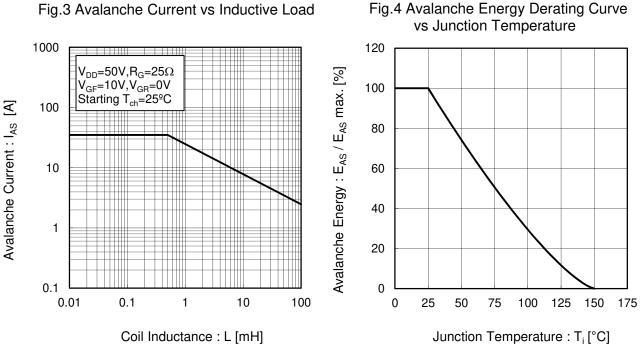
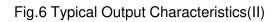
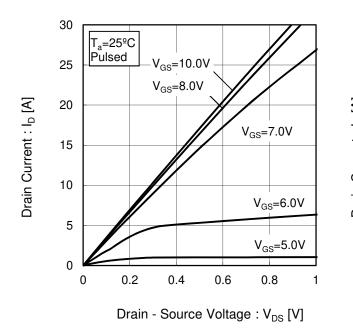
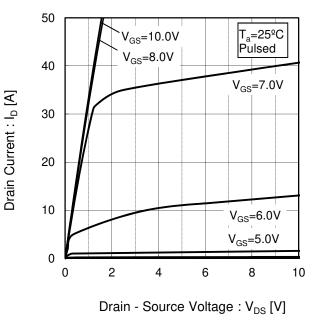


Fig.3 Avalanche Current vs Inductive Load

Fig.5 Typical Output Characteristics(I)







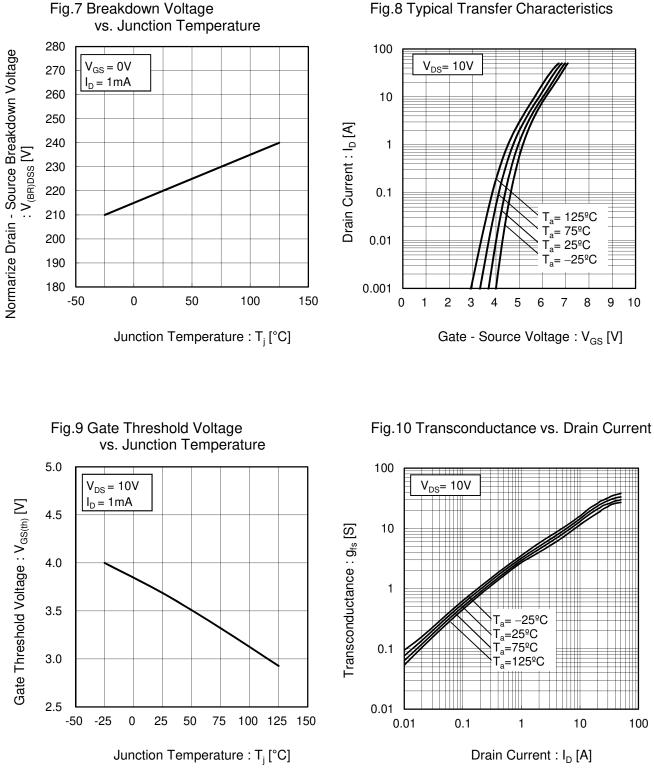
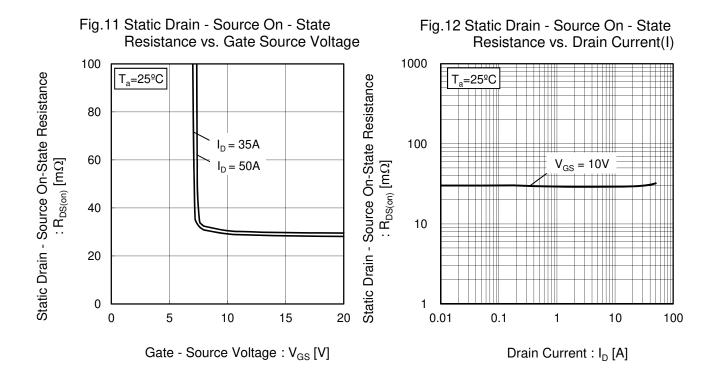
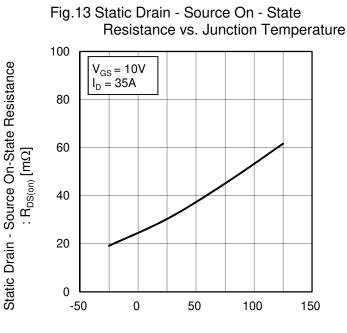
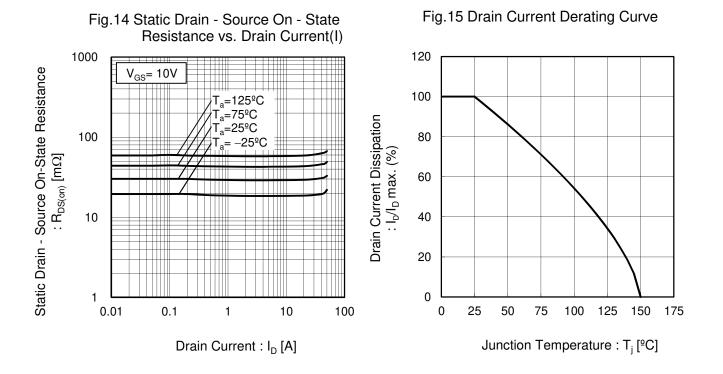


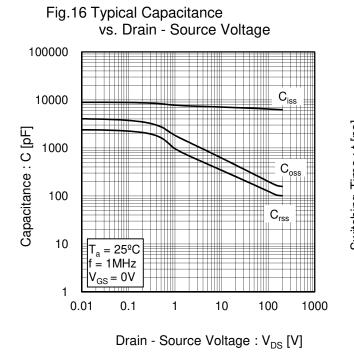
Fig.8 Typical Transfer Characteristics





Junction Temperature : T_j [°C]





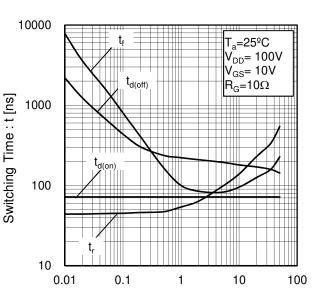
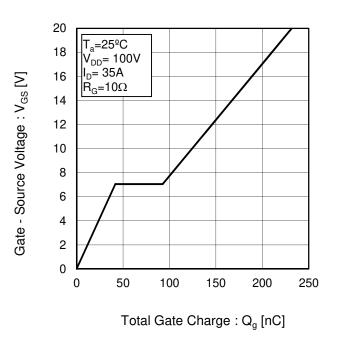


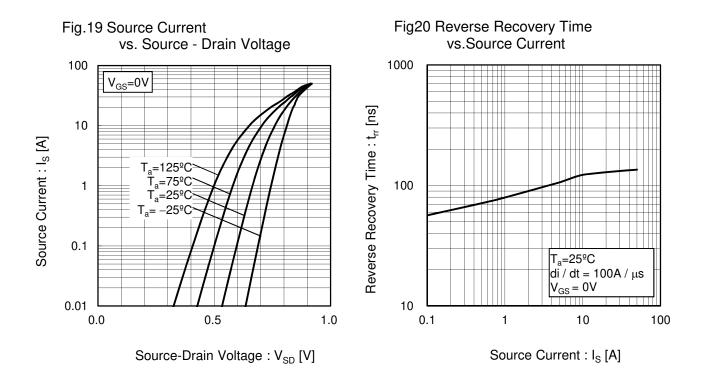
Fig.17 Switching Characteristics

Drain Current : I_D [A]

Fig.18 Dynamic Input Characteristics



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Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

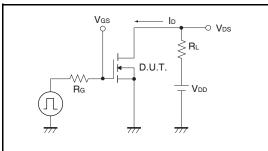


Fig.2-1 Gate Charge Measurement Circuit

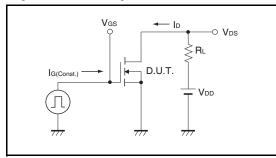


Fig.3-1 Avalanche Measurement Circuit

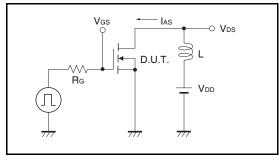


Fig.1-2 Switching Waveforms

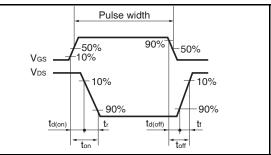


Fig.2-2 Gate Charge Waveform

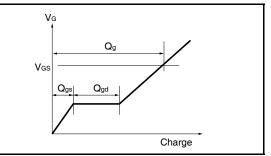
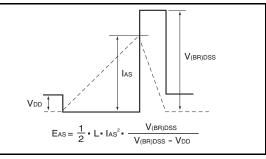
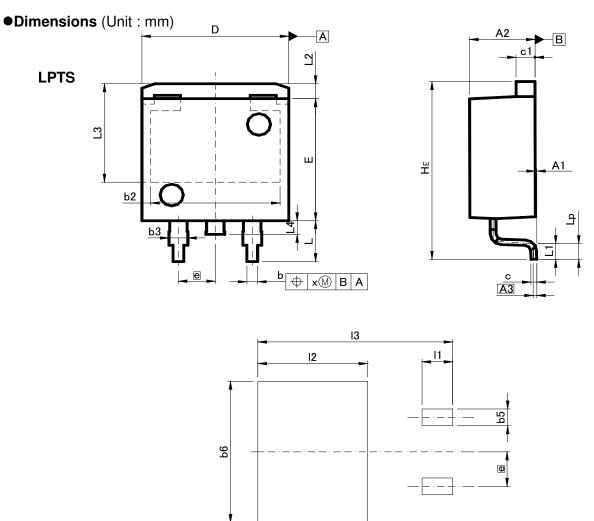


Fig.3-2 Avalanche Waveform





Pattern of terminal position areas [Not a recommended pattern of soldering pads]

| DIM | MILIM | ETERS | INC | HES | |
|-----|-------|-------|-------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| A1 | 0.00 | 0.30 | 0.000 | 0.012 | |
| A2 | 4.30 | 4.70 | 0.169 | 0.185 | |
| A3 | | 25 | 0.0 | | |
| b | 0.68 | 0.98 | 0.027 | 0.039 | |
| b2 | 8. | 90 | 0.3 | | |
| b3 | 1.14 | 1.44 | 0.045 | 0.057 | |
| С | 0.30 | 0.60 | 0.012 | 0.024 | |
| c1 | 1.10 | 1.50 | 0.043 | 0.059 | |
| D | 9.80 | 10.40 | 0.386 | 0.409 | |
| E | 8.80 | 9.20 | 0.346 | 0.362 | |
| е | 2. | 2.54 | | 00 | |
| HE | 12.80 | 13.40 | 0.504 | 0.528 | |
| L | 2.70 | 3.30 | 0.106 | 0.130 | |
| L1 | 0.90 | 1.50 | 0.035 | 0.059 | |
| L2 | 1. | 10 | 0.0 | 0.043 | |
| L3 | 7.25 | | 0.2 | 85 | |
| L4 | | 00 | 0.0 | | |
| Lp | 0.90 | 1.50 | 0.035 | 0.059 | |
| х | - | 0.25 | - | 0.010 | |
| | | | | | |
| DIM | MILIM | ETERS | INC | HES | |
| | MIN | MAX | MIN | MAX | |
| b5 | _ | 1.23 | - | 0.049 | |
| b6 | - | 10.40 | - | 0.409 | |
| 11 | - | 2.10 | - | 0.083 | |
| 12 | - | 7.55 | - | 0.297 | |
| 13 | _ | 13.40 | - | 0.528 | |

Dimension in mm / inches

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| (Note1) Medical Equipment Classification of the S | pecific Applications |
|---|----------------------|
|---|----------------------|

| JAPAN | USA | EU | CHINA |
|--------|----------|------------|---------|
| CLASSⅢ | CLASSⅢ | CLASS II b | CLASSII |
| CLASSⅣ | CLASSIII | CLASSⅢ | CLASSI |

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 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
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- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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